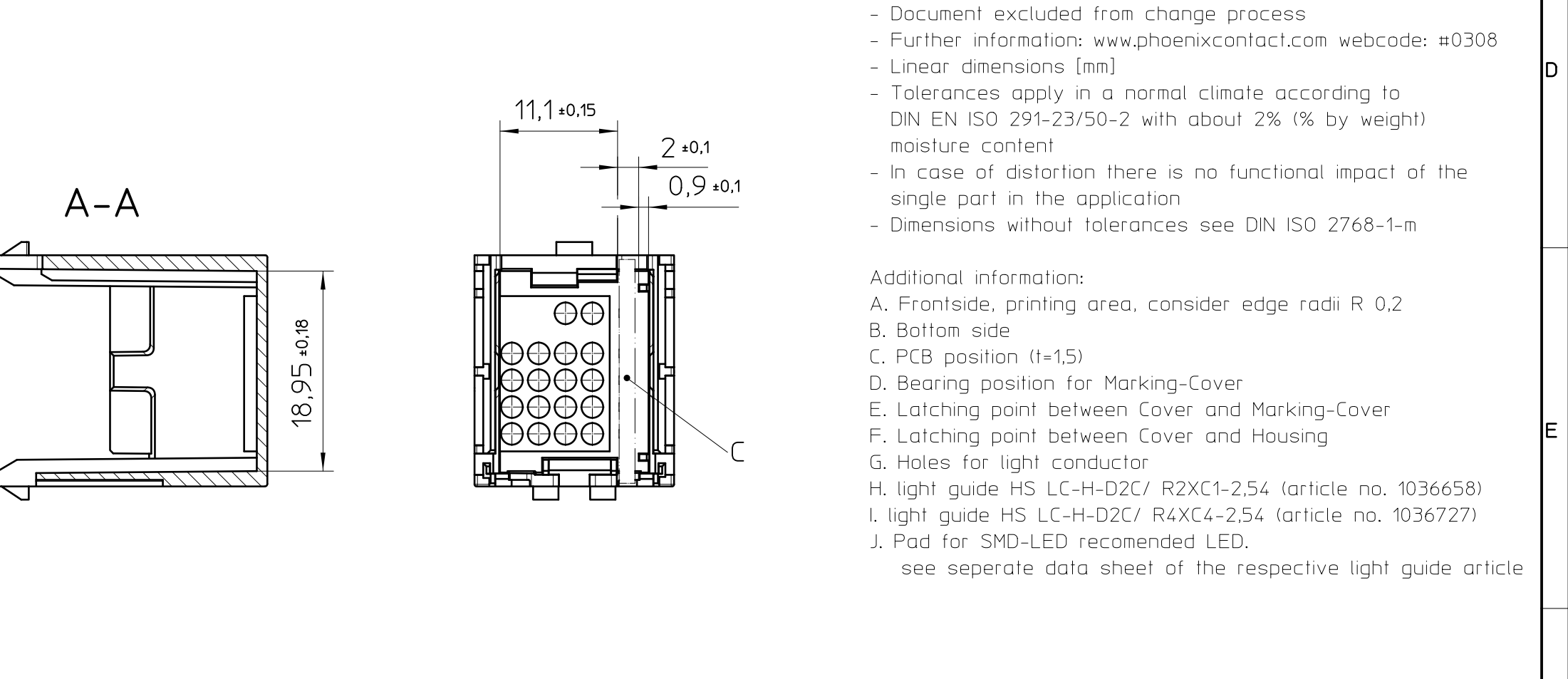
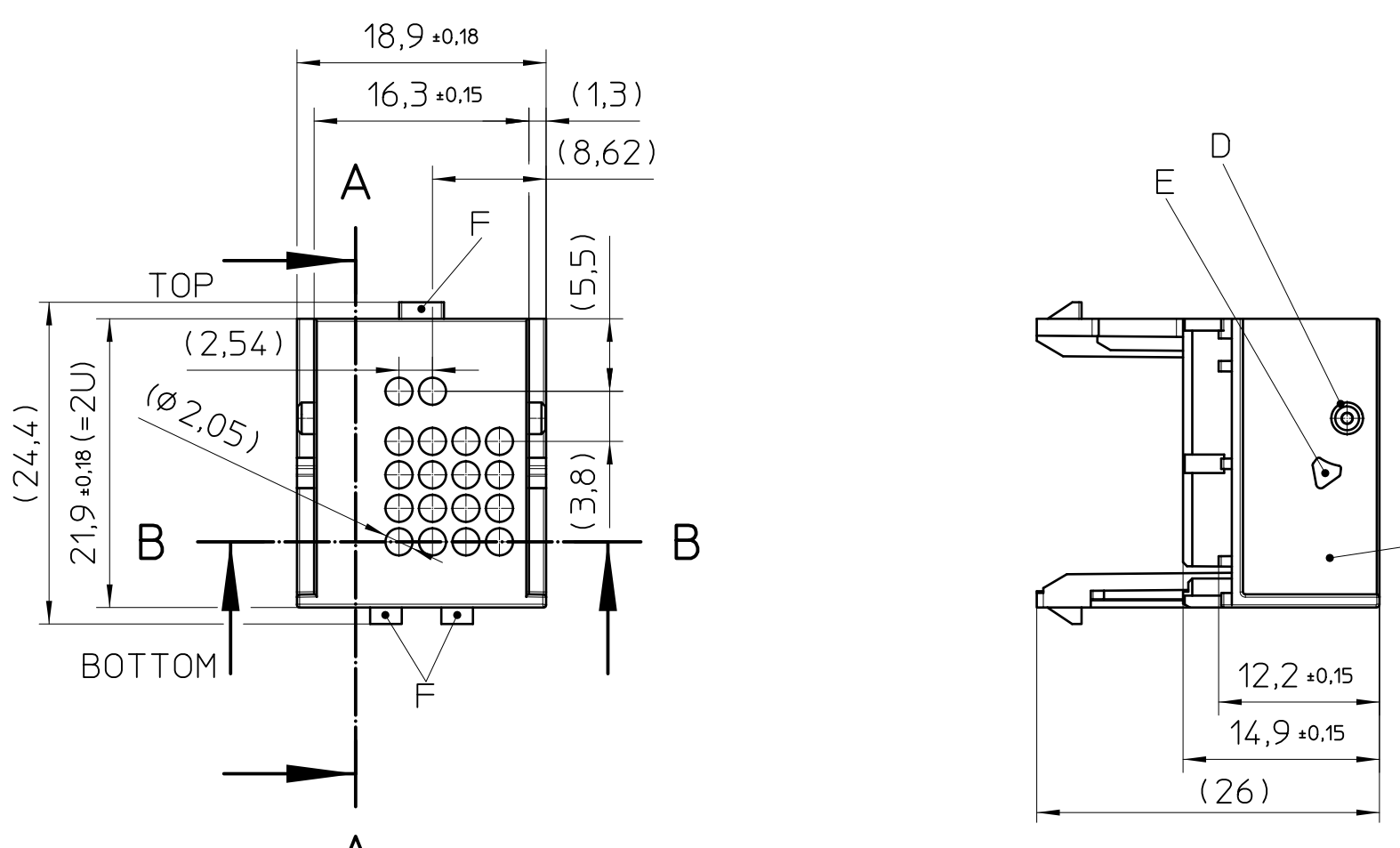
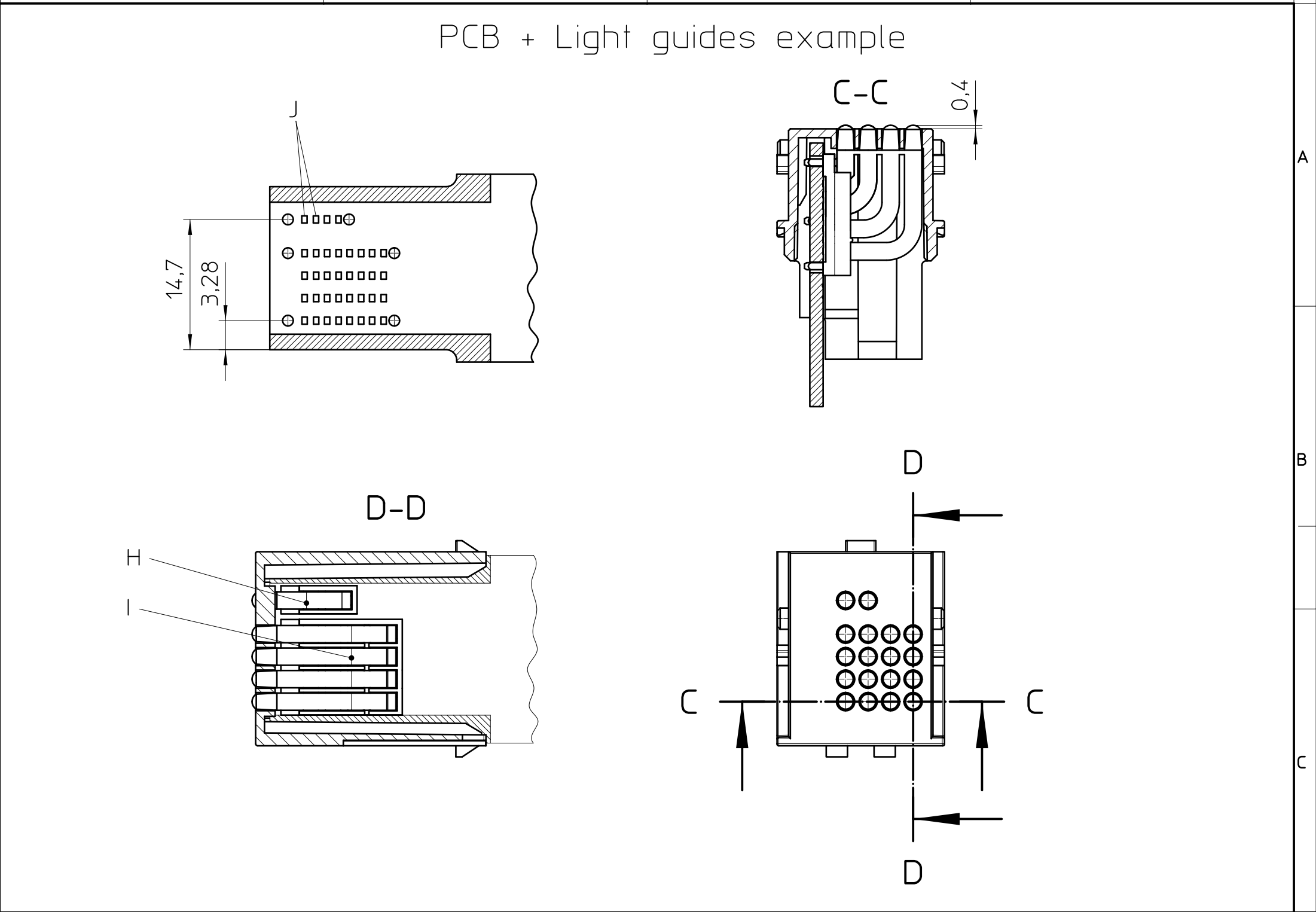
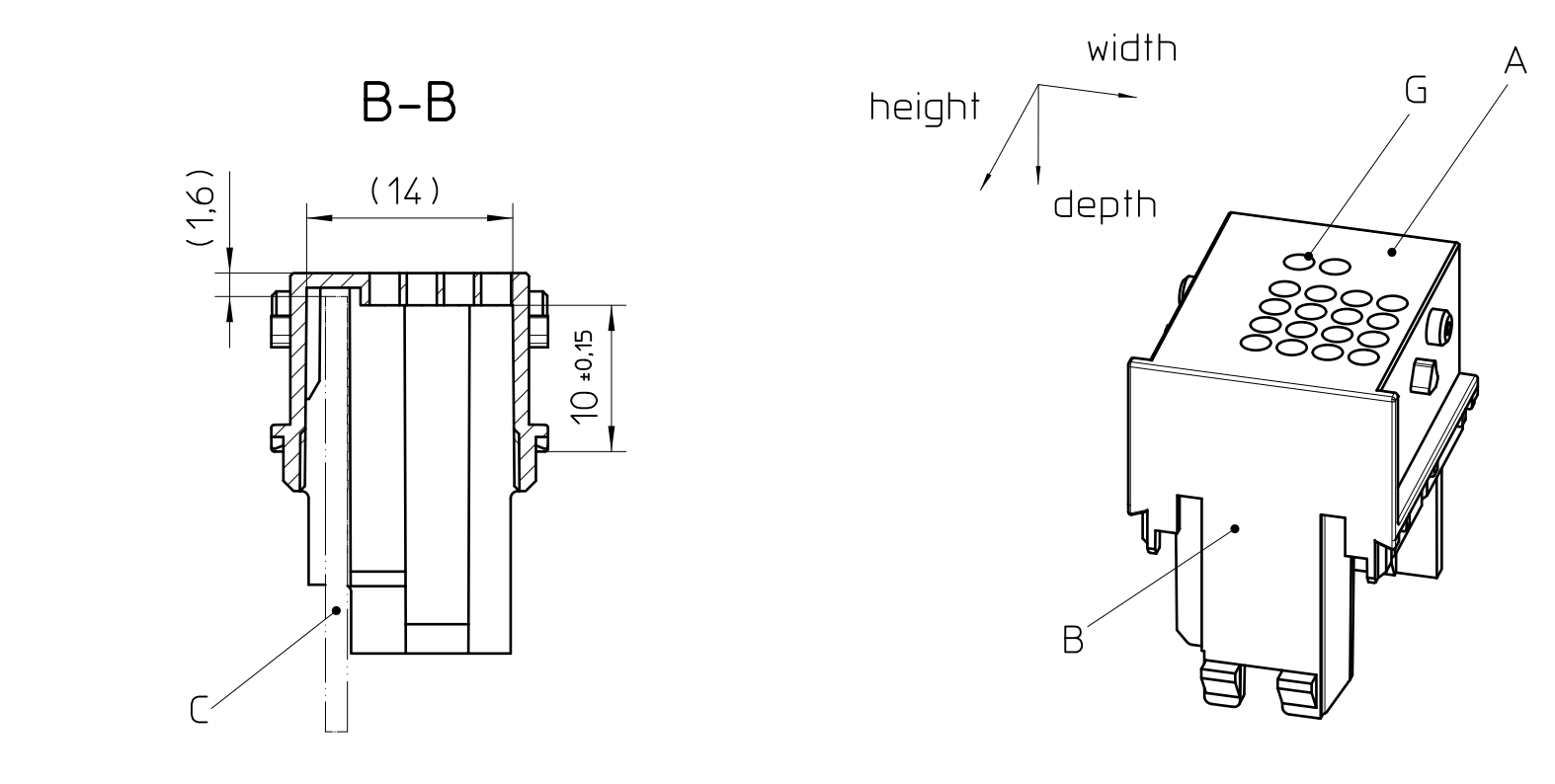


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General Information

- Simplified representation
- Document excluded from change process
- Further information: www.phoenixcontact.com webcode: #0308
- Linear dimensions [mm]
- Tolerances apply in a normal climate according to DIN EN ISO 291-23/50-2 with about 2% (% by weight) moisture content
- In case of distortion there is no functional impact of the single part in the application
- Dimensions without tolerances see DIN ISO 2768-1-m

Additional information:

- A. Frontside, printing area, consider edge radii R 0,2
- B. Bottom side
- C. PCB position (t=1,5)
- D. Bearing position for Marking-Cover
- E. Latching point between Cover and Marking-Cover
- F. Latching point between Cover and Housing
- G. Holes for light conductor
- H. light guide HS LC-H-D2C/ R2XC1-2,54 (article no. 1036658)
- I. light guide HS LC-H-D2C/ R4XC4-2,54 (article no. 1036727)
- J. Pad for SMD-LED recommended LED.

see separate data sheet of the respective light guide article

Pos.	QTY	description	material
1	1	COVER	PA

 DIN A2	document-No. / RI	date	scale
	00967971 / 05	29.04.2025	2:1
	ident.-No.	document-type	
	1486135	TECDOC 2D_Productdrawing	
page 1	of 1	description	
ME-IO 18,8 C 2U MC18 5015			